

COMPOSITE FORMING SMD INDUCTORS

AL5060624-1 series

Features:

Large Current and Low DCR.

Magnetically shielded construction.

High frequency range up to 3.0 MHz.

RoHS compliant* and halogen free.

Low noise.

Operating temperature range: -55°C TO +150°C

AEC-Q200 qualified.

Applications:

Notebooks/Desktops/Server applications.

DC/DC converters.

LED drivers

Noise suppression for motors: windshield wipers

BO

/ powerseats / power mirrors / heating and

ventilation blower /HID lighting

DC/DC converters for entertainment / navigation

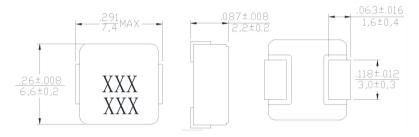
systems

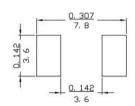
Product identification:



Dimensions (unit:inch/ mm):

Recommended Layout: [unit: inch/ mm]





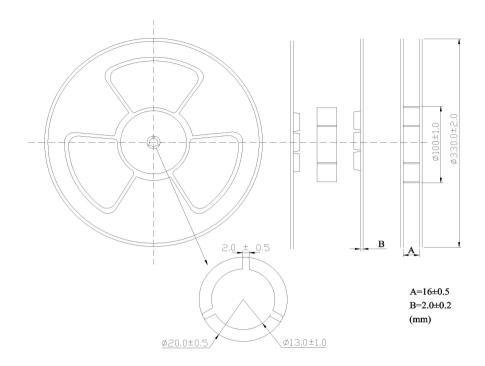
Electrical Specifications @ 25℃									
	100KHz /1.0V	D.C.R (mΩ)		Heat Rating Current	Saturation Current				
P/N	L0(µH) ±20% '@0A	Typical	Max	ldc (Amp) Typical	Isat (Amp) Typical				
AL5060624R22M1	0.22	2.7	3.1	20	32				
AL5060624R33M1	0.33	3.2	3.6	17	28				
AL5060624R47M1	0.47	5.4	6	15	20				
AL5060624R68M1	0.68	7.3	8.1	11	18				
AL50606241R0M1	1	11.5	12.5	10	15				
AL50606241R5M1	1.5	18	20.6	9	12				
AL50606242R2M1	2.2	23	26	6.5	11				
AL50606243R3M1	3.3	28.5	32	6	6				
AL50606244R7M1	4.7	53	63	4	5				
AL50606246R8M1	6.8	68	76	3.5	4				
AL5060624100M1	10	112	125	2.6	2.9				

Note:

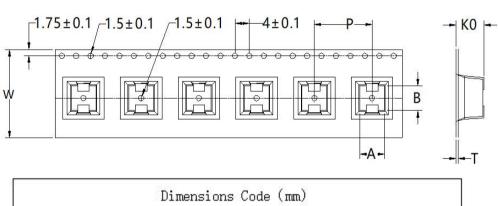
- ·All test date is referenced to 25°C ambient.
- •DC current(Idc) that will cause an approximate $\triangle T$ of 40 $^{\circ}$ C.
- •DC current(last) that will cause Lo to drop approximately 20%.
- •Operating temperature range:-55°C to +150°C.
- The part temperature (ambient + temp rise) should not exceed125°C under the worst operating conditions. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

Packaging

1) Reel dimensions

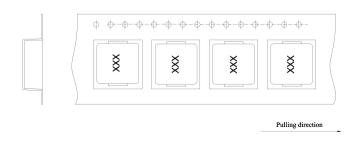


2) Tape packaging dimensions

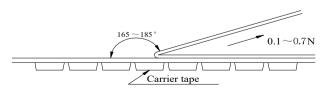


	Dimensions Code (mm)								
60	A	В	W	P	Т	K0			
0	7±0.1	8±0.1	16±0.3	12±0.1	0.35±0.05	2.7±0.1			

3) Tape Direction



4) Peel force of top cover tape



The peel speed shall be about 300 mm/minute The peel force of top cover tape shall be between 0.1 to 1.3N

Reminders

Please pay sufficient attention to the warnings for safe designing when using these products.

- * The storage period is less than 12 months. Be sure to follow the storage conditions (Temperature: 5 to 40°C Humidity:10 to 75% RHor less).
 - If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- * Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
- Before soldering, be sure to preheat components.

 The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperaturedoes not exceed 150°C.
- * Soldering corrections after mounting should be within the range of the conditions determined in the specifications.
 - If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- % Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermaldesign.
- ※ Do not expose the products to magnets or magnetic fields.
 Do not use for a purpose outside of the contents regulated in the delivery specifications.

Tel: +86 -769 -86761589 http://www.fpe.com.cn